FEATURES

• High CMRR: typ. 90 dB at 60Hz

- Wide bandwidth: typ. >8.6 MHz

- Low distortion: typ. 0.0006% THD

• Several gains: 0 dB, ± 3 dB, ± 6 dB

• Excellent audio performance

– High slew rate: typ. 12 V/ μ s

- Low noise: typ. -104 dBu

• Low current: typ. 2 mA

Industry Standard Pinout

THAT 1240, 1243, 1246

APPLICATIONS

- Balanced Audio Line Receivers
- Instrumentation Amplifiers
- Differential Amplifiers
- Precision Summers
- Current Shunt Monitors

Description

The THAT 1240-series of precision differential amplifiers was designed primarily for use as balanced line receivers for audio applications. Gains of 0 dB, ± 3 dB, and ± 6 dB are available to suit various applications requirements.

These devices are laser trimmed in wafer form to obtain the precision resistor matching needed for high CMR performance and precise gain. Manufactured in THAT Corporation's proprietary complementary dielectric isolation (DI) process, the THAT 1240-series provides the sonic benefits of discrete designs with the simplicity, reliability, matching, and small size of a fully integrated solution.

All three versions of the part typically exhibit 90 dB of common-mode rejection. With 12 V/ μ s slew rate, >8.6 MHz bandwidth, and 0.0006 % THD, these devices are sonically transparent. Moreover, current consumption is typically a low 2 mA. Both surface-mount and DIP packages are available.

The THAT 1246 is pin-compatible with the TI INA137 and Analog Devices SSM2143, while the THAT 1240 is pin-compatible with the INA134 and the SSM2141.



Figure 1. THAT 1240-series equivalent circuit diagram

Pin Name	DIP Pin	SO Pin
Ref	1	1
In-	2	2
In+	3	3
Vee	4	4
Sense	5	5
Vout	6	6
Vcc	7	7
NC	8	8

Table 1. 1240-series pin assignments

Gain	Plastic DIP Plastic S			
0 dB	1240P08-U	1240S08-U		
±3 dB	1243P08-U	1243S08-U		
±6 dB	1246P08-U	1246S08-U		

Table 2. Ordering information

SPECIFICATIONS¹

Absolute Maximum Ratings^{2,3}

Supply Voltages (V _{CC} - V _{EE})	40V	Storage Temperature Range (T_{ST})	-40 to +125 ⁰C
Maximum In. or In. Voltage	$-50V + V_{CC}, 50V + V_{EE}$	Operating Temperature Range (T _{OP})	0 to +85 °C
Max/Min Ref or Sense Voltage	V_{CC} + 0.5V, V_{EE} - 0.5V	Output Short-Circuit Duration (t_{SH})	Continuous
Maximum Output Voltage (V _{OM})	V_{CC} + 0.5V, V_{EE} - 0.5V	Junction Temperature (T _J)	+125 ⁰C

	Ľ	lectrical Characteristics				
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Supply Current	Icc	No signal		2.0	2.8	mA
Supply Voltage	$V_{\text{CC}}\text{-}V_{\text{EE}}$		6	—	36	V
Input Voltage Range	$V_{\text{IN-DIFF}}$	Differential (equal and opposite swing)				
		1240 (0dB gain)	_	21.5		dBu
		1243 (-3dB gain)	—	24.4	—	dBu
		1246 (-6dB gain)	—	27.5	_	dBu
	$V_{\text{IN-CM}}$	Common Mode				
		1240 (0dB gain)	_	27.5	_	dBu
		1243 (-3dB gain)	_	29.1	_	dBu
		1246 (-6dB gain)	—	31	—	dBu
Input Impedance ⁵	$Z_{\text{IN-DIFF}}$	Differential				
		1240 (0dB gain)	_	18	_	kΩ
		1243 (-3dB gain)	_	21	_	kΩ
		1246 (-6dB gain)	_	24	_	kΩ
	Z _{IN-CM}	Common Mode				
		All versions	—	18	_	kΩ
Common Mode Rejection Ratio	CMRR	Matched source impedances; $V_{CM} = \pm 10 V$	/			
		DC	70	90	_	dB
		60Hz	70	90	_	dB
		20kHz	—	85	—	dB
Power Supply Rejection Ratio ⁶	PSRR	$\pm 3V$ to $\pm 18V$; V _{CC} = -V _{EE} ; all gains	_	90		dB
Total Harmonic Distortion	THD	$V_{IN DIFF} = 10$ dBV, f = 1kHz, BW = 22kHz, RL	– 2 kO			
	me			0.0006	—	%
Output Noise	eout	22 Hz to 22kHz bandwidth				
		1240 (0dB gain)	_	-104	_	dBu
		1243 (-3dB gain)		-105	_	dBu
		1246 (-6dB gain)	—	-106	—	dBu
Slew Rate	SR	$R_L = 2k\Omega$; $C_L = 300 \text{ pF}$, all gains	7	12	_	V/µs

All specifications are subject to change without notice.
 Unless otherwise noted, T_A=25°C, V_{CC}=+15V, V_{EE}= -15V.
 Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; the functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
 O dBu = 0.775 Vrms.
 While specific rating rate vary expected timened absolute registrance values can vary +25% from the twicel values chown. Input impedance in

4. 0 dou = 0.773 vitus.
 5. While specific resistor ratios are very closely trimmed, absolute resistance values can vary ±25% from the typical values show n. Input impedance is monitored by lot sampling.
 6. Defined with respect to differential gain.
 7. Parameter guaranteed over the entire range of power supply and temperature.

	Electrica	al Characteristics (con't) ^{2,}	4		
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Small signal bandwidth	BW-3dB	$R_{L} = 2k\Omega; C_{L} = 10 \text{ pF}$ 1240 (0dB gain) 1243 (-3dB gain) 1246 (-6dB gain) R_{L} = 2k\Omega; C_{L} = 300 \text{ pF} 1240 (0dB gain)		8.6 12.2 18 10.3		MHz MHz MHz MHz
		1243 (-3dB gain) 1246 (-6dB gain)	_	11.8 13.4	_	MHz MHz
Output Gain Error	G _{ER-OUT}	f = 1 kHz	-0.05	0	+0.05	dB
Output Voltage Swing	V _{O+} V _{O-}	$\begin{array}{l} R_{L} = 2k\Omega\\ R_{L} = 2k\Omega \end{array}$	V _{cc} -2.5	V _{CC} -2 V _{EE} +2	 V _{EE} +2.5	V V
Output Offset Voltage	V _{OFF}	No signal	-7	_	+7	mV
Output Short Circuit Current	I _{sc}	$R_L = 0 \ \Omega$	_	±25	_	mA
Capacitive Load ⁷	CL		_	_	300	pF



Figure 2. THAT 1240 series test circuit

Theory of Operation

The THAT 1240-series ICs consist of high performance opamps with integrated, laser-trimmed resistors. These designs take full advantage of THAT's fully complementary dielectric isolation (DI) process to deliver excellent performance with low current consumption. The devices are simple to apply in many applications.

Resistor Trimming, Values, and CMRR

The 1240-series devices rely upon proprietary, laser-trimmed, silicon-chromium (Si-Cr), thin-film, integrated resistors to deliver the precise matching required to achieve a 90 dB common mode rejection ratio. Trimming is performed in two cycles, both using dc inputs. First, gain is set by trimming the R_1/R_2 pair. Then, CMRR is set by trimming the other pair (R_3/R_4). Generally, only one resistor of each pair is trimmed (whichever needs to increase to meet the required specification).

To achieve 90 dB CMRR, the R_3/R_4 ratio is trimmed to within ± 0.005 % of the R_1/R_2 ratio. Since the resistors themselves are on the order of 10 k Ω (see Figure 1 for actual values, which change with the specific part), an increase of as little as 0.6 Ω can reduce the CMRR from over 90 dB to only 84 dB. The better the starting CMRR, the more impact (in dB) a given added resistance will have.

THAT Corporation: 45 Sumner Street; Milford, MA 01757-1656; USA Tel: +1 508 478 9200; Fax: +1 508 478 0990; Web: www.thatcorp.com Copyright © 2008, THAT Corporation Page 4 of 8

Therefore, to achieve this high CMRR in practice, care should be taken to ensure that all source impedances remain balanced. To accomplish this, PCB traces carrying signal should be balanced in length, connector resistance should be minimized, and any input capacitance (including strays) should be balanced between the + and - legs of the input circuitry. Note that the additional contact resistance of some sockets is sufficient to undo the effects of precision trimming. Therefore, socketing the parts is not recommended. THAT's 1200-series InGenius® input stages address many of these difficulties through a patented method of increasing commonmode input impedance.

A further consideration is that after trimming, the two resistor divider ratios are tightly controlled, but the actual value of any individual resistor is not. In fact, two of the four resistors are normally left without trimming. The initial tolerance of the resistors is quite wide, so it is possible for any given resistor to vary over a surprisingly wide range, Lot-to-lot variations of up to ± 30 % are to be expected.

Input Considerations

The 1240-series devices are internally protected against input overload via an unusual arrangement of diodes connecting the + and - Input pins to the power supply pins. The circuit of Figure 3 shows the arrangement used for the R_3/R_4 side; a similar one applies to the other side. The zener diodes prevent the protection network from conducting until an input pin is raised at least 50 V above $V_{\rm CC}$ or below $V_{\rm EE}$. Thus, the protection networks protect the devices without constraining the allowable signal swing at the input pins. The reference (and sense) pins are protected via more conventional reverse-biased diodes which will conduct if these pins are raised above $V_{\rm CC}$ or below $V_{\rm EE}$.

Because the 1240-series devices are input stages, their input pins are of necessity connected to the outside world. This is likely to expose the parts to ESD when cables are connected and disconnected. Our testing indicates that the 1240-series devices will typically withstand application of up to 1,000 volts under the human body ESD model.

To reduce risk of damage from ESD, and to prevent RF from reaching the devices, THAT recommends the circuit of Figure 4. C₃ through C₅ should be located close to the point where the input signal comes into the chassis, preferably directly on the connector. The unusual circuit design is intended to minimize the unbalancing impact of differences in the values of C_4 and C_5 by forcing the capacitance from each input to chassis ground to depend primarily on the value of C₃. The circuit shown is approximately ten times less sensitive to mismatches between C_4 and C_5 than the more conventional approach, in which the junction of C_4 and C_5 is grounded directly. An excellent discussion of input stage grounding can be found in the June 1995 issue of the Journal of the Audio Engineering Society, Vol. 43, No. 6, in articles by Stephen Macatee, Bill Whitlock, and others.

Note that, because of the tight matching of the internal resistor ratios, coupled with the uncertainty

in absolute value of any individual resistor, RF bypassing through the addition of R-C networks at the inputs (series resistor followed by a capacitor to ground at each input) is not recommended. The added resistors can interact with the internal ones in unexpected ways. If some impedance for the RF-bypass capacitor to work against is deemed necessary, THAT recommends the use of a ferrite bead or balun instead.

If it is necessary to ac-couple the inputs of the 1240-series parts, the coupling capacitors should be sized to present negligible impedance at any frequencies of interest for common mode rejection. Regardless of the type of coupling capacitor chosen, variations in the values of the two capacitors, working against the 1240-series input impedance (itself subject to potential imbalances in absolute value, even when trimmed for perfect ratio match), can unbalance common mode input signals, converting them to balanced signals which will not be rejected by the CMRR of the devices. For this reason, THAT recommends dc-coupling the inputs of the 1240-series devices.

Input Voltage Limitations

When configured, respectively, for -3 dB and -6 dB gain, the 1243 and 1246 devices are capable of accepting input signals above the power supply rails. This is because the internal opamp's inputs connect to the outside world only through the on-chip resistors R_1 through R_4 at nodes a and b as shown in Figure 2. Consider the following analysis.

Differential Input Signals

For differential signals $(v_{IN(DIFF)})$, the limitation to signal handling will be output clipping. The outputs of all the devices typically clip at within 2V of the supply rails. Therefore, maximum differential input signal levels are directly related to the gain and supply rails.

Common Mode Input Signals

For common-mode input signals, there is no output signal. The limitation on common-mode handling is the point at which the inputs are overloaded. So, we must consider the inputs of the opamp.

For common mode signals ($v_{in(CM)}$), the common mode input current splits to flow through both R_1/R_2 and through R_3/R_4 . Because vb is constrained to follow va, we will consider only the voltage at node a.

The voltage at a can be calculated as:

$$v_a = v_{IN(CM)} \left[\frac{R_4}{R_3 + R_4} \right]$$

Again, solving for $v_{\mbox{\scriptsize IN(CM)}}$,

$$v_{IN(CM)} = v_a \left[\frac{R_3 + R_4}{R_4} \right]$$

For the 1240, $(R_3 + R_4) / R_4 = 2$. For the 1243, $(R_3 + R_4) / R_4 = 2.4$. For the 1246, $(R_3 + R_4) / R_4 = 3$. Furthermore, the same constraints apply to v_a as in the differential analysis.



Figure 3. Representative input protection circuit

Following the same reasoning as above, the maximum common mode input signal for the 1240 is $(2V_{CC} - 4)$ V, and the minimum is $(2V_{EE} + 4)$ V. For the 1243, these figures are $(2.4V_{CC} - 4.8)$ V, and $(2.4V_{EE} + 4.8)$ V. For the 1246, these figures are $(3V_{CC} - 6)$ V, and $(3V_{EE} + 6)$ V.

Therefore, for common-mode signals and ± 15 V rails, the 1240 will accept up to ~ 26 V in either direction. As an ac signal, this is 52 V peak-peak, 18.4 V rms, or ± 27.5 dBu. With the same supply rails, the 1243 will accept up to ~ 31 V in either direction. As an ac signal, this is 62 V peak-peak, 21.9 V rms, or ± 29 dBu. With the same supply rails, the 1246 will accept up to ~ 39 V in either direction. As an ac signal, this is 78 V peak-peak, 27.6 V rms, or ± 31 dBu.

Of course, in the real world, differential and common-mode signals combine. The maximum signal that can be accommodated will depend on the superposition of both differential and common-mode limitations.

Output Considerations

The 1240-series devices are typically capable of supplying 25 mA into a short circuit. While they will survive a short, power dissipation will rise dramatically if the output is shorted. Junction temperature must be kept under 125 $^{\rm o}{\rm C}$ to maintain the devices' specifications.

These devices are stable with up to 300 pF of load capacitance.

Power Supply Considerations

The 1240-series parts are not particularly sensitive to the power supply, but they do contain wide bandwidth opamps. Accordingly, small local bypass capacitors should be located within a few inches of the supply pins on these parts, as shown in Figure 4.

Selecting a Gain Variation

The three different parts offer different gain structures to suit different applications. The 1246 is customarily configured for -6 dB gain, but by reversing the resistor connections, can also be configured for +6 dB. The 1243 is most often configured for -3 dB gain, but can also be configured for +3 dB. The choice of input gain is determined by the input voltage range to be accommodated, and the power supply voltages used within the circuit.

To minimize noise and maximize signal-to-noise ratio, the input stage should be selected and configured for the highest possible gain that will ensure that maximum-level input signals will not clip the input stage or succeeding stages. For example, with ± 18 V supply rails, the 1240-series parts have a maximum output signal swing of +23 dBu. In order to accommodate +24 dBu input signals, the maximum gain for the stage is -1 dB. With ± 15 V supply rails, the maximum output signal swing is $\sim +21.1$ dBu; here, -3 dB is the maximum gain. In each case, a 1243 configured for -3 dB gain is the ideal choice. The 1240 (0dB gain only) will not provide enough headroom at its output to support a +24 dBu input signal. The 1246 (configured for -6 dB gain) will increase noise, thus reducing dynamic range, by attenuating the input signal more than necessary to support a +24 dBu input.

In fact, for most professional audio applications, THAT recommends the -3 dB input configuration possible only with the 1243 in order to preserve dynamic range within a reasonable range of power supply voltages and external headroom limits.



Figure 4. RFI and supply bypassing



Figure 5. Zero dB line receiver

Applications

The THAT 1240, 1243, and 1246 are usually thought of as precision differential amplifiers with gains of zero, -3 and -6 dB respectively. These devices are primarily intended as balanced line receivers for audio applications. However, their topology lends itself to other applications as well.

Basic Balanced Receiver Applications

Figures 5, 6, and 7, respectively, show the THAT 1240, 1246, and 1243 configured as zero, -6 dB, and -3 dB line receivers. Figures 8 and 9, respectively, show the 1243 and 1246 configured as +3 dB and +6 dB line receivers. The higher gains are achieved by swapping the positions of the resistors within each pair in regard to signal input vs. output.

Figure 10 shows a THAT 1240 configured as a precision summing amplifier. This circuit uses both the In+ and Ref pins as inputs. Because of the excellent matching between the laser-trimmed resistor pairs, the output voltage is precisely equal to the sum of the two input voltages.

More Complex Applications

Figure 11 shows a 1240 configured as an instrumentation amplifier. The two opamps preceding the 1240 provide gain equal to 1+(9.998 k Ω / R_g). The 1240 rejects common mode signals while accepting balanced ones.

Figure 12 shows a convenient method of driving a typical audio ADC with balanced inputs. This circuit accepts +24 dBu in. By using a pair of THAT 1246 ICs connected in anti-phase, the signal level



Figure 6. -3 dB line receiver



Figure 7. -6 dB line receiver

between their respective outputs is +24 dBu. An attenuator network brings this signal down by 24 dB while attenuating the noise of the line receivers as well.

The output noise of a THAT 1246 is -106 dBu, and since there are two of them, the total noise level going into the resistive pad will be -103 dBu. The pad reduces the noise level to -127 dBu at the input to the ADC. The noise density resulting from the line receivers will therefore be

$$e_{n \ line \ receiver} = \frac{10^{\left(\frac{-127dBu}{20}\right)} \times 0.775}{\sqrt{20kHz}} = 2.45 \frac{nV}{\sqrt{Hz}}$$

The thermal noise of the 249 Ω resistor is 2.05 nV//Hz. We can assume that the noise contribution of $R_{\rm s}$ and $R_{\rm 19}$ will be negligible, and therefore, the total noise density going into the input of the ADC will be

$$e_{n total} = \sqrt{(2.45 \frac{nV}{\sqrt{Hz}})^2 + (2.06 \frac{nV}{\sqrt{Hz}})^2} = 3.2 \frac{nV}{\sqrt{Hz}}.$$

The noise floor can then be calculated to be

$$Noise_{(dBu)} = 20 \log \frac{3.2 \frac{nV}{\sqrt{Hz}} \times \sqrt{20kHz}}{0.775} = -124.7 \ dBu$$

Figure 13 shows the recommended method for controlling gain in a balanced system. In such circuits, designers are often tempted to keep the signal balanced and use two Voltage Controlled Amplifiers (VCAs) to independently control the gain on each half of the balanced signal. Unfortunately, this can result in common-mode to differential mode



Figure 8. +3 dB line receiver



Figure 9. +6 dB line receiver



Figure 10. Precision two-input summing circuit

conversion (degrading CMRR) when there are even slight differences in gain between the VCAs. A better approach is to convert the signal to single-ended, alter the gain, and then convert back to balanced.

In Figure 13 we use a THAT 1243 -3 dB line receiver to do the balanced-to-single-ended conversion. The VCA section also has a static gain of -3 dB due to the ratio of R_2 to R_3 . This circuit can accept



Figure 11. Instrumentation amplifier

+24 dBu, since the THAT 1243 output stage is capable of accepting 21 dBu without distortion. Reducing R_3 to 14 $k\Omega$ results in a 3 dB reduction in VCA output noise. This arrangement results in 3 dB greater dynamic range compared to the case where a -6 dB line receiver and a VCA with zero dB static gain are used. After the VCA, the signal is restored to 24 dBu by the THAT 1606.



Figure 12. Circuit for audio ADCs with balanced inputs



Figure 13. Automated gain control of a balanced signal

Package Information

The THAT 1240 series is available in 8-pin PDIP and 8-pin surface mount (SOIC) packages. Package dimensions are shown below;

The 1240 series packages are entirely lead-free. The lead-frames are copper, plated with successive layers of nickel, palladium, and gold. This approach makes it possible to solder these devices using leadfree and lead-bearing solders. Neither the lead-frames nor the plastic mold compounds used in the 1240-series contains any hazardous substances as specified in the European Union's Directive on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment 2002/95/EG of January 27, 2003. The surface-mount package is suitable for use in a 100% tin solder process

]	Package Characteristic	s			
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Through-hole package		See Fig. 14 for dimensions		8 Pin PDIF	b	
Thermal Resistance	θ_{JA}	DIP package soldered to board		100		°C/W
Environmental Regulation C	ompliance	Complies v	vith Janua	ary 27, 2003	3 RoHS req	uirements
Surface mount package		See Fig. 15 for dimensions		8 Pin SOP)	
Thermal Resistance	θ_{JA}	SO package soldered to board		150		°C/W
Soldering Reflow Profile		J	EDEC JE	SD22-A113	3-D (250 ℃)	
Moisture Sensitivity Level	MSL	Above-referenced JEDEC soldering prof	ile	1		
Environmental Regulation C	ompliance	Complies v	vith Janua	ary 27, 2003	3 RoHS req	uirements



Figure 14. -P (DIP) version package outline drawing



Figure 15. -S (SO) version package outline drawing